



1.0 SCOPE

This specification defines the performance for the 2 PIN POGO connector 2.0 PRODUCT DESCRIPTION

This Pogo-Pin consists of two contact pins, two springs, two solder pads, two fittings and a housing, For materials, plating see below Product Name: BTC36 Series

3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

See product drawing (according to the newest revised edition) and other sections of this specification for the relevant reference documents and specifications. In cases where the specification differs from the product drawings, the product drawings take precedence.

4.0 RATINGS

4.1	Rated Current (per contact)	3A Max.
4.2	Rated Voltage	5V DC
4.3	Operating temperature range	-40°C~ +85°C .
4.4	Dielectric Withstanding Voltage	500V AC

5.0 ELECTRICAL PERFORMANCE

Test Ref.	ltem	Test Condition	Requirements
5.1	Contact Resistance (LLCR)	Mate connector with circuit of 20mV, 100mA Max. Measured from pin side to shaft side, 4.78mm working height EIA 364-23;	50 milliohms Max(Initial)
5.2	Insulation Resistance	Unmate & mate connectors: apply a voltage of 500 VDC between adjacent terminals and between terminals to ground for 1 minute. EIA 364-21	100 Mega Ohm Min.
5.3	Dielectric Withstanding Voltage	Apply 500 VAC for 1 minute between adjacent terminals of an unmated connector. EIA 364-20	No breakdown;

REVISION:	ECR/ECN	ECN INFORMATION: NO BTC36 SERIES				5	SHEET No	
Α	<u>EC No:</u> DATE:	PDR- A17000 2017/02/	4.	PRODUCT NAME	2	PIN Pogo pin Con	nector	2 of 5
DOCUN	IENT NUME	BER: CRE		CREATED / REVISED BY:		CHECKED BY:	<u>APPROV</u>	ED BY:
PS-	PS-BC-0116			LINDA		JERRY.TUNG KIMI		ISU



6.0 MECHANICAL PERFORMANCE

Test Ref.	ltem	Test Condition	Requirements
6.1	Durability	Operation Speed: 10~20cycles/minute. Durability Cycles: 10,000 Cycles EIA 364-09C	[Contact Resistance]: 50mΩMaximum,
6.2	Normal Force	Measure normal force at contact point, @4.78mm working height EIA-364-04	[Normal force]: 50~80g
6.3	Vibration	Subject mated connectors to 10-500 Hz traversed in 1minutes at 1.52mm amplitude for 2 Hour each of 3 mutually perpendicular planes.98.1 m/s ² EIA 364-28D	<1µs discontinuity
6.4	Mechanical Shock	Accelerate Velocity: 490m/ s ² (50G) Waveform: 11ms Half-sine shock Velocity Change: 3.4m/s No. of Drops: 3 drops each to normal and reversed directions of X,Y and Z axes, totally 18 drops, passing 1mA current during the test. EIA 364-27B	<1µs discontinuity
6.5	Fully compression	Compress connector to 0mm from housing by hand for 10sec	[Appearance]: no damage

7.0 ENVIRONMENTAL PERFORMANCE

Test Ref.	ltem	Test Condition	Requirements
7.1	Humidity	Mate connectors: expose to a temperature of 40±2°C with a relative humidity of 90~95% for 96hours Note: Remove surface moisture and air dry 48 hours prior to measurements. EIA 364-31B	[Appearance]: no damage [Contact Resistance]: 50 mΩ maximum
7.2	Low Temperature Exposure	48 hours at -40°C 1hours recovery time EIA 364-59	[Appearance]: no damage [Contact resistance]: 50 mΩ maximum
7.3	High Temperature Exposure	48 hours at +85℃ Less than 25% relative humidity 1hours recovery time EIA 364-17B	[Appearance]: no damage [Contact resistance]: 50 mΩ maximum

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Α	<u>EC No:</u> DATE:	PDR- A17000 2017/02/	4.	PRODUCT NAME	2	2 PIN Pogo pin Connector			
DOCUM	IENT NUME	BER: CRE		CREATED / REVISED BY:		CHECKED BY:	<u>APPROV</u>	ED BY:	
PS-	PS-BC-0116			LINDA		JERRY.TUNG	KIMI.I	ISU	

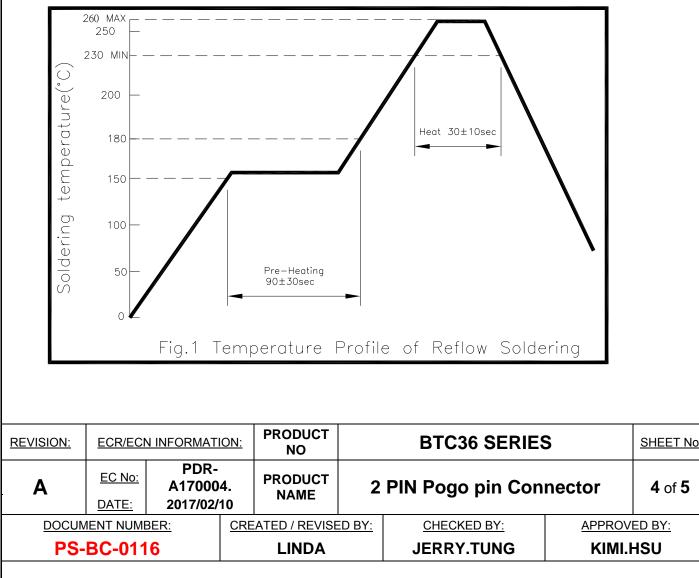


7.4	Thermal Shock	Place free situation samples in chamber with 10 cycles, and one duration is $-40^{\circ}C/(0.5h) \rightarrow 25^{\circ}C/(5minutes Max.)$ $\rightarrow 85^{\circ}C/(0.5h) \rightarrow 25^{\circ}C/(5minutes Max.).$ EIA-364-32C	[Appearance]: no damage. [Contact Resistance]: 50 mΩ maximum
7.5	Salt Spray Test	Duration: 48 hours exposure; Atmosphere:salt spray from a 5% solution. Temperature: 35 +1/-2°C EIA 364-26B	[Appearance]: no damage.
7.6	Solderability Test	Dip solder tails into the molten solder(held at $245\pm5^{\circ}$ C for 3 ± 0.5 sec. EIA 364-52	[Solder coverage]: 95% Min.
7.7	Resistance to reflow soldering heat	Place connector applicable P.C.B. footprint and float on solder bath at 250 +5/ -0°C Reference to following Table A and Fig.1. EIA 364-56	[Appearance]: no damage .

8.0 PACKAGING

Parts shall be packaged to protect against damage during handling, transit and storage.

9.0 RECOMMENDED REFLOW PROFILE





10.0 TEST GROUP

			Т	est	Gro	oup							
Toe	tltome		Test Sequence										
165	Test Items Contact Resistance(LLCR)		В	С	D	Е	F	G	Н	I	J	Κ	L
		1,5	1,7	1,5	1,5	1,5	1,5	1,5	1,5	1,5	1,5	1,3	1,3
	n Resistance	2,4	2,6	2,4	2,4	2,4	2,4	2,4	2,4	2,4	2,4		
	Withstanding	3											
	oltage												
	rability		4										
	nal Force		3,5										
	oration			3									
Mechar	nical Shock				3								
Fully co	ompression					3							
Hu	imidity						3						
Low Te	emperature							3					
	posure												
	emperature								3				
	posure												
Therm	nal Shock									3			
	pray Test										3		
Soldera	ability Test											2	
	nce to reflow												2
	ering heat												
Sam	ple(Pcs)	3	3	3	3	3	3	3	3	3	3	3	3
	CR/ECN INFORMAT	ION:	PROD)			BTC	36 \$	SERI	ES			SHEET
A E	CR/ECN INFORMAT	<u>10N:</u> 9 4.) ОСТ	2	2 PIN					ctor		<u>SHEET</u>
A E	<u>C No:</u> A17000 ATE: 2017/02 /	1 <u>011:</u> 14. 110	NC PROD NAM	О		2 PIN	Ρος		n Co			ROVE	5 of
A <u>E</u>	C No: ATE: NUMBER: PDR- A17000 2017/02/	1 <u>011:</u> 14. 110	NC PROD NAM TED / F	D UCT ME				jo pi	n Cc <u></u>		APP		5 of <u>D BY:</u>

ACRON 文件制訂、修訂、廢止申請單

文件編號	PS-BC-0116	文件名稱	BTC	36 Serie	es Spec.	
申請部門	業務部	申請人	Tiara		日期	2/10'17
制訂單位	工程部	制訂人	Linda		日期	2/10'17
副 制 訂	PDR	-A170004 新制	定			
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